# SPECIFICATIONS FOR NICHIA BLUE LASER DIODE

MODEL: NUBM37

NICHIA CORPORATION

### 0. Specifications

Blue laser diode: NUBM37

(In this specification, the blue laser diode is referred to as "LD", and the laser diode chip mounted on the LD is referred to as "LD chip".)

### 1. Specifications

(1) Features

Forward Current: 3.0A(CW Operation), Tm=75°C, ACC(Auto Current Control) Operation

(2) Absolute Maximum Ratings

| 7                                       |        |                                 |      |  |  |
|---|--------|---------------------------------|------|--|--|
| Item                                    | Symbol | <b>Absolute Maximum Ratings</b> | Unit |  |  |
| Forward Current (Tm=25°C) *1)           | If     | 3.5                             | A    |  |  |
| Allowable Reverse Current (Tm=25°C) *1) | Ir(LD) | 85                              | mA   |  |  |
| Storage Temperature                     | Tstg   | <b>-40</b> ∼ 85                 | °C   |  |  |
| Operating Temperature *2)               | Tm     | 0 ~ 75                          | °C   |  |  |

<sup>\*1)</sup> Individual LD chip

(3) Initial Electrical/Optical Characteristics

(Tm=25°C)

| 5) Initial Electrical Spring Characteristics |                            |                       |                       |      |        |      | m 23 C) |
|--|----------------------------|-----------------------|-----------------------|------|--------|------|---------|
|  | Item                       | Symbol                | <b>Test Condition</b> | Min. | Тур.   | Max. | Unit    |
| Optical Output Power                         |                            | Po                    | If=3.0A               | 115  | (125)  | -    | W       |
| Dominant Wave                                | elength *3)                | λd                    | If=3.0A               | 449  | (455)  | 461  | nm      |
| Threshold Current                            |                            | Ith                   | CW Operation          | 220  | -      | 420  | mA      |
| Slope Efficiency                             |                            | η                     | CW Operation          | -    | (46)   | -    | W/A     |
| Operating Voltage *4)                        |                            | Vop                   | If=3.0A               | 93   | (98)   | 103  | V       |
| Beam Pointing                                | Individual LD chip *5)     | Δθ                    | If=3.0A               | -    | -      | 1.1  | 0       |
| Tilt Angle                                   | Average of 24 LD chips *6) | $\Delta \theta_{AVE}$ | If=3.0A               | -    | -      | 0.7  | 0       |
| Beam   | Parallel                   | θ//                   | If=3.0A               | 0.12 | (0.42) | 0.72 | 0       |
| Divergence *7)                               | Perpendicular              | $\theta \bot$         | If=3.0A               | -1.5 | (0)    | 1.5  | 0       |

All figures in this specification are measured by Nichia's method and may contain measurement deviations. () are reference figures.

<sup>\*2)</sup> Refer to Fig.1

<sup>\*3)</sup>  $\lambda d$  is defined from trichromatic coordinate (x, y) values on chromaticity diagram calculated from the peak intensity higher than  $1/e^2$  shown in Fig.2.

<sup>\*4)</sup> When connected in series with the 24 LD chips.

<sup>\*5)</sup> Beam Pointing Tilt Angle  $\Delta\theta = \sqrt{\Delta\theta_{\parallel}^2 + \Delta\theta_{\perp}^2}$  (Individual LD chip)

<sup>\*6)</sup> Average absolute value of Individual Beam Pointing Tilt Angle.

<sup>\*7)</sup> Full angle at 1/e<sup>2</sup> from peak intensity (Individual LD chip)

(4) Lifetime Characteristics

| Item                       | Symbol | Test Condition              | Min. | Тур.    | Max. | Unit |
|----------------------------|--------|-----------------------------|------|---------|------|------|
| Estimated Lifetime *8) *9) | 1.0    | Cumulative Failure Rate 50% | 8000 | (20000) | -    | hrs  |
|                            | Life   | Cumulative Failure Rate 1%  | 1000 | -       | -    | hrs  |

() are reference figures.

Cumulative failure rate is calculated by the parameter greater than 500pcs.

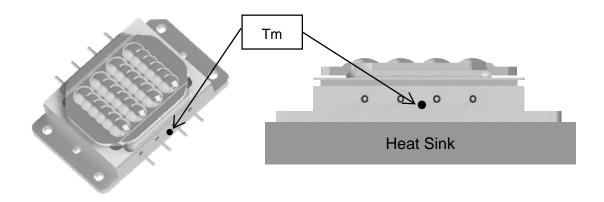


Fig.1 Schematic diagram of measurement system

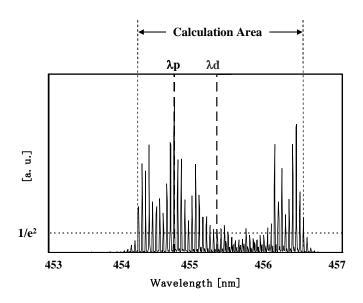


Fig.2 Definition of Dominant Wavelength

<sup>\*8)</sup> Condition: Tm=75°C, ACC, If=3.0A (CW), N=24LD chips (Refer to Fig.3: 6series × 4 connection)

<sup>\*9)</sup> Calculation Method: Estimated in the linear extrapolation by degradation rate at tested duration 1000 hrs. Criteria for Judging the Defect of Lifetime: Po×0.5

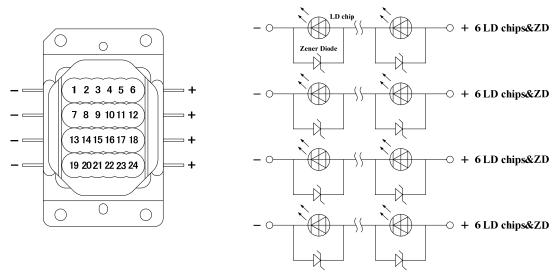


Fig.3 24LD chips Drive Circuit

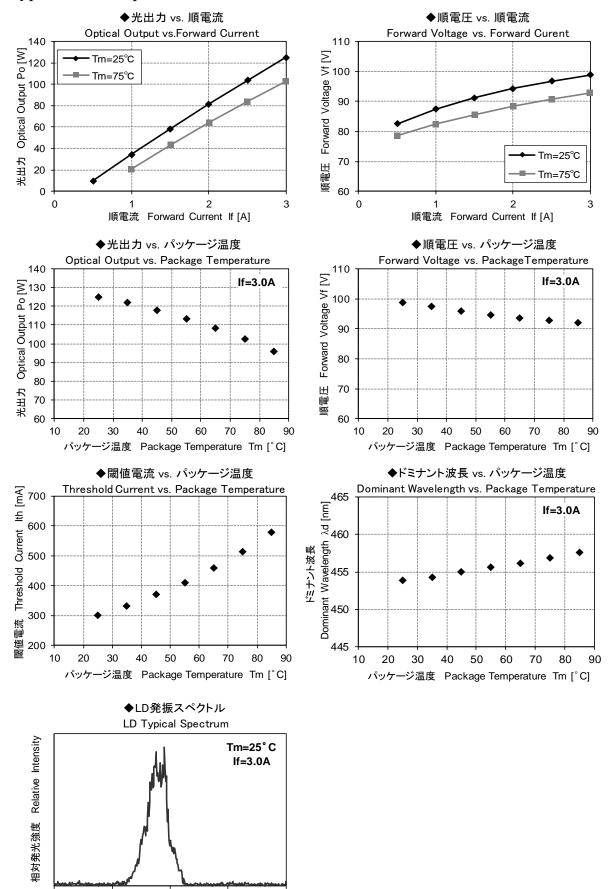
## 2. Outline Dimensions and Materials

Refer to the outline dimension pages within this specification.

## 3. Packaging

Refer to the packaging page within this specification.

# 4. Typical Initial Optical/Electrical Characteristics



465

460

455

波長 Wavelength  $\lambda$  [nm]

445

450

# 5. Reliability

(1) Test Items and Test Conditions

| Test Item   | Test Conditions  | Note       | Compliant<br>Standard     | Criteria<br>for<br>Judging |
|---|--|------------|---------------------------|----------------------------|
| Resistance<br>to Soldering Heat<br>(Hand Soldering) | Tsld = $350 ^{\circ}\text{C} \pm 10 ^{\circ}\text{C}$ , 5 sec. (2mm from the base of the lead) | 2 times    |                           | A                          |
| Solderability                                       | Tsld = 245 °C $\pm$ 5 °C, 5 sec.<br>Lead-free solder (Sn-3.0Ag-0.5Cu)                          | 1 time     | JEITA ED-4701<br>301 303A | В                          |
| Temperature Cycle                                   | -40°C (30min.) ~ 85°C (30min.)   | 100 cycles | JEITA ED-4701<br>100 105  | A                          |
| Vibration   | 200 m/s <sup>2</sup> , $100 \sim 2000 \sim 100$ Hz (4min.)<br>4 cycles of each X,Y,Z           | 48 min.    | JEITA ED-4701<br>400 403  | A                          |
| Shock   | 15000 m/s <sup>2</sup> , 0.5ms<br>X,Y,Z  | 3 times    | JEITA ED-4701<br>400 404  | A                          |
| High Temperature<br>Storage                         | Ta = 85 °C   | 1000hrs.   | JEITA ED-4701<br>200 201  | A                          |
| Temperature<br>Humidity Storage                     | Ta = 85 °C, RH = 85 %  | 1000hrs.   | JEITA ED-4701<br>100 103  | A                          |
| Low Temperature<br>Storage                          | Ta = -40 °C  | 1000hrs.   | JEITA ED-4701<br>200 202  | A                          |
| Life Test   | Tm=75°C, If=3.0A(CW), ACC Operation  | 1000hrs.   |                           | С                          |

(2) Criteria for Judging the Failure

|   | Item                 | Symbol | Test Conditions     | Criteria for Judging the Failure   |
|---|----------------------|--------|---------------------|--|
|   | Operating Voltage    | Vop    | If=3.0A (series)    | >Initial value×1.1<br><initial td="" value×0.9<=""></initial>                        |
| A | Optical Output Power | Po     | If=3.0A             | >Initial value×1.1<br><initial td="" value×0.9<=""></initial>                        |
|   | Beam Tilt Angle      | Δθ     | If=3.0A             | >Initial value +0.5deg.<br><initial -0.5deg.<="" td="" value=""></initial>           |
| В | Appearance           | _      | Solderability       | Less than 95% (except for the plating contact point and the 0.5mm from the lead tip) |
| С | Optical Output Power | Po     | Life Test Condition | >Initial value×1.1<br><initial td="" value×0.9<=""></initial>                        |

#### 6. Cautions

- Semiconductor devices, including Nichia laser diodes (the LD), can be damaged or fail in certain probability. The probability can be largely affected by the circuit used and/or environmental conditions. The following precautions should be carefully reviewed and followed to avoid the risk of any damage or failure.
- When incorporating the modules, equipment, systems, etc., Purchaser must acknowledge that any LD can be failed statically and must design its equipments fail safe design to avoid consequential bodily and/or property damage.
- This LD uses a resin to secure the lens. The securing strength will be sufficient under normal use; however, depending on how the LDs are used, the lens may be removed. To ensure the safety and reliability of the LDs, ensure that the following precautions are followed when using the LDs.

#### 1. LASER BEAM CAN DAMAGE EYES:

• Laser Light can damage the human eyes and skin. Do not expose the eye or skin to laser light directly. This Laser product has an optical lens and emits a collimated laser beam. The light from this product, both direct and reflected, is very harmful as it can propagate a long distance while maintaining high optical density. When handling the product, wear appropriate safety glasses to protect eyes from laser light including reflected and stray light. The reflected and stray light spilling into an unintended area should be attenuated and/or absorbed.

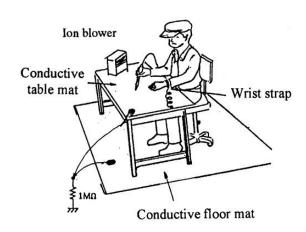


- When handling the LD, wear appropriate safety glasses to prevent laser light, even any reflections from entering to the eyes.
- Use of the LD should conform to Class 4 of the IEC60825-1 and 21 CFR Part 1040.10 Safety Standards.

#### 2. Static Electricity and Electrical Surges:

Static electricity or electrical surges will reduce and degrade the reliability of the LD. When working with the LDs take countermeasures to avoid the generation of static electricity, including the following:

- Use or wear appropriate work clothes, gloves, shoes, grounded wrist straps and other tools to avoid static electricity.
- Wrist band must be grounded by high resistance (1M Ohm) wire.
- Use anti-static case for transport and storage of the LD.
- Use fully grounded workbenches, soldering tools, equipment and circuits. Especially, soldering iron must be leak-free type. Ground the equipment and the circuit to be connected, and surge current must be blocked at the power supply.
- Insulating materials will not release static electricity. Use ion blower to neutralize the electrostatic.
- To prevent electrostatic generation, maintain environmental humidity more than 40%.
- Do not connect or disconnect oscilloscope probes or voltage meter cables when the LD is operated. That may cause surge.
- Do not use the LD near a Glow Electric Discharge Tube or similar equipment, due to the chance of inducing an electrical surge by high frequency noise.



#### 3. Absolute Maximum Ratings:

Active layer of mounted LD chips shall have high current density and generate high electric field during its operation. In order to prevent excessive damage, the LD must be operated strictly below Absolute Max Rating.

The LD will have shorter lifetime if used at higher temperature. In order to elongate the lifetime, design the equipment to use the LD at lower temperature and lower output power.

During operation, if the forward current and/or optical output power are increased the lifetime of the LDs will decrease. Ensure that the LDs are operated within the recommended conditions.

#### 4. Operating Power Supply:

When adjusting the operation current, make sure to simultaneously monitor the optical output power by power meter.

The LD shall change its Vf requirement and optical output power according to temperature change. Also, the LD will require more operation current to maintain same output power as it degrades. In order to maintain output power, use of APC (Automatic Power Control) is recommended, which use feedback of the optical output power to adjust the operation current.

Confirm that electrical spike current generated by switching on and off does not exceed the maximum operating current level specified herein above as absolute max rating. Also, employ appropriate countermeasures to reduce chattering and/or overshooting in the circuit.

ACC (Auto Current Control) mode is recommended for the Product operation. Also, please be careful for the overshooting in order to avoid excessive optical output power as the laser operation is started.

#### 5. <u>Design Consideration</u>:

LDs may fail as either a short circuit or an open circuit. If an LD shorts during operation, the forward voltage of the LD may fluctuate greatly. When designing a circuit, ensure that both short and open circuits are considered and that there will be no issues if a short or open circuit occurs.

Since this LD uses a resin to secure the lens, if the lens becomes removed during operation, it may cause unintentional laser exposure to occur (e.g. random radiation) leading to accidents/injuries (e.g. causing an object to smoke, fire, and the laser light to escape). Ensure that the chosen system includes a safeguard (e.g. containing the laser light, emergency shutdown, etc.).

#### 6. Heat Sink:

The use of heat sinks is strongly recommended to reduce increases in temperature and in the operating current of the LD. If the heat dissipation capability is not sufficient, the temperature of the LD will increase, light output power will decrease, and the LD could be damaged or destroyed due to escalating increases in temperature and in the operating current.

It is recommended that the base plate of the LD should firmly touch the heat sink panel in order to efficiently dissipate heat. Heat sink characteristics depend significantly on its construction, materials and shape. The selection of the heat sink and the design of the circuit should take into account heat resistance and dissipation.

#### 7. Storage:

Rapid fluctuations in the storage temperature and/or humidity should be avoided both before and after opening the antistatic bag. After opening the antistatic bag, the storage conditions should be a temperature within the range of 5°C to 35°C and a relative humidity within the range of 40% to 75%. Before opening the antistatic bag, any storage temperatures and humidity levels which are outside of those parameters should be avoided.

The package (including the leads) of the product except glass part is plated. The plating surface may be deteriorated by corrosive gases or similarity.

The LD must be stored in clean atmospheric environment, and recommended to be assembled at the earliest timing.

The LD shall be used within one year after the receipt. Shelf life is one year.

#### 8. Installation and Soldering:

Do not apply excessive stress to the leads, because it may deteriorate hermetically. Excessive stress to the plate of the LD can cause the plate to deform or break, or cause deterioration to the LD characteristics.

- This product is designed to be hand soldered. If reflow soldered, Nichia cannot guarantee its reliability.
- <u>Bending leads</u>: Bend the leads of the LD at a point no closer than 2 mm from the base of a lead on the LD. Maximum bending angle is 90 degree.
- Tensile/Indentation load: Maximum tensile load or indentation load on lead is 5N.
- <u>Soldering temperature</u>: Keep soldering Iron at less than 350 degrees Celsius (662 degrees Fahrenheit), and for no longer than 3 seconds.
- <u>Soldering position</u>: Solder the leads at a point no closer than 2 mm from the base of a lead on the LD.
- Do not solder the base plate of the LD directly onto the heat sink panel.
- Do not heat directly to the glass part of the base of a lead.
- Do not attach solder and others to the glass of part the base of a lead.

Do not add excessive stress and/or shock to the product because it can cause the plate to deform and the glass breakage, therefore cause deterioration to the product characteristics.

#### 9. Beam Shape; Lens Care:

- The beam from the LD forms a collimated oval shape that has been corrected by the lens array.
- The shape of the beam must be converged by the appropriate lens to conform to the utility of the circuit.
- Handle the LD carefully to avoid damage to or staining of its lens surface because those may cause to decrease light output power and change the beam shape.
- Due to its short wavelength and high optical output power, optical depositions on optical path may occur depending on surrounding conditions. Appropriate design or countermeasures should be used to avoid optical depositions.

### 7. Limited Warranty

#### **Limited Warranty**

- (1) Nichia warrants that the LD itself, not incorporated into any module, equipment and/or system designed and/or manufactured by any party other than Nichia, shall perform in accordance with its specifications. This warranty shall become immediately null and void if any of Nichia's instructions set forth above are not followed.
- (2) The Purchaser must acknowledge that any LD can statistically fail and must design its equipments in a fail safe design. It is Purchaser's responsibility to confirm that the LD, as described in Nichia's specifications, meets the life expectancy needs of, and provides the features required by the Circuit and any related modules, equipment and/or systems.
- (3) This LD is intended to be used for household appliances, electronic devices (e.g. mobile communication devices); it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, automobiles, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LD is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health.

This LD does not comply with ISO/TS 16949 and is not intended for automotive applications.

#### Warranty Service

Warranty service is available during the one (1) year period commencing on the date of shipment from Nichia. During the Warranty Period, if the Purchaser finds failure or defect, following process shall be taken:

- (1) Fill in and send "Questions for Laser Damage Analysis" to Nichia and obtain Return Authorization Number (RA number)
- (2) Return to QA Manager Nichia Corp. 491 Oka, Kaminaka-Cho Anan-Shi, Tokushima 774-8601, JAPAN. The Purchaser must bear all packaging, handling, insurance and shipping costs that incurred related to returning the LD to Nichia.
- (3) Nichia shall conduct full analysis of the returned LD. If Nichia determines that the LD fails to meet the Limited Warranty above, Nichia will send the Purchaser equivalent quantity of replacement LDs. If Nichia determines that the LD was damaged after the shipment from Nichia, Nichia shall contact the Purchaser, at which time the Purchaser may request either service of the LD by Nichia (at its standard fees therefore) or return of the LD to Purchaser.

#### Disclaimer of Warranties

NICHIA HEREBY DISCLAIMS ALL OTHER WARRANTIES INCLUDING, BUT NOT LIMITED TO, IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.

#### **Limitation of Liability**

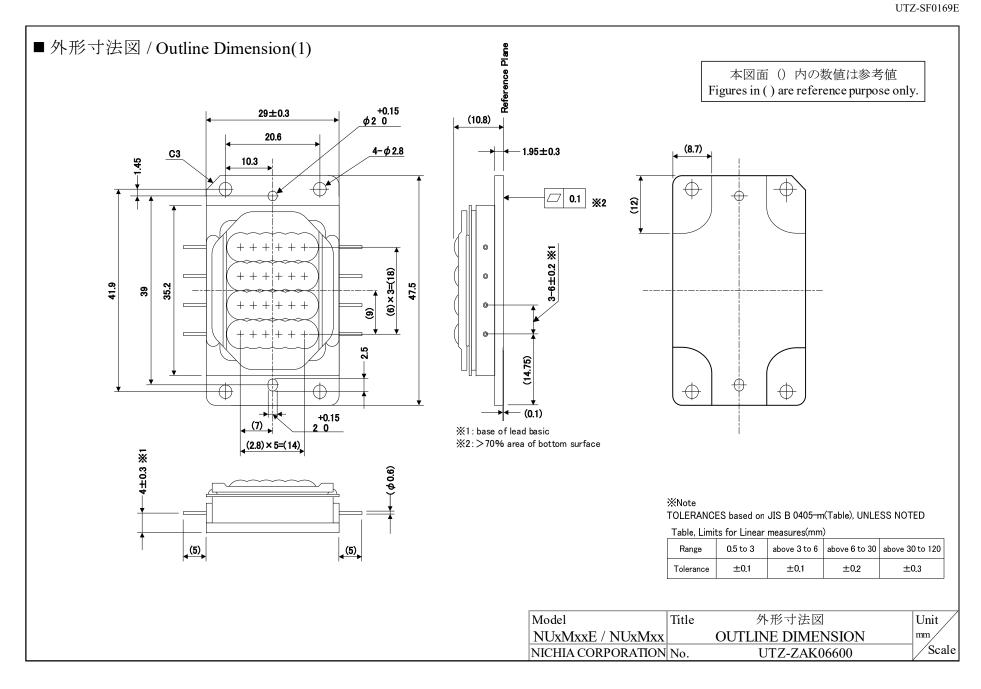
THE PURCHASER'S SOLE REMEDY IN THE EVENT OF A BREACH OF THE ABOVE WARRANTY SHALL BE, AT NICHIA'S OPTION AND IN ITS SOLE DISCRETION, REPAIR OR REPLACEMENT OF THE LD. NICHIA SHALL HAVE NO OTHER LIABILITY WITH REGARD TO ANY OTHER DAMAGES INCURRED BY PURCHASER WITH REGARD TO ANY DEFECTIVE LD, INCLUDING, BUT NOT LIMITED TO, LIABILITY RESULTING FROM ANY ACCIDENT, DAMAGE OR INJURY RELATED TO THE LD CAUSED BY ACCIDENT, MISUSE, ABUSE, NEGLECT, MISAPPLICATION, INCORRECT USE OF ELECTRICAL VOLTAGE, ELECTRICAL FLUCTUATIONS OR SURGES CAUSED BY IMPROPER OR FAULTY INSTALLATION, CONNECTIONS WITH ANY **OTHER** CIRCUITS, PERIPHERALS OR LDS, LD ALTERATION OR MODIFICATION, UNAUTHORIZED REPAIR, COSMETIC DAMAGE OR CUSTOMER ADJUSTMENTS, USE OF UNAUTHORIZED PARTS OR EQUIPMENT WHICH DAMAGE OR CAUSE FAILURE OF THE LD, PROBLEMS DUE TO INCOMPATIBILITY WITH ANY OTHER MODULE, EQUIPMENT OR SYSTEM, OR ANY ACTS OF NATURE.

#### Reverse Engineering

Nichia prohibit Purchaser from reverse engineering, disassembling, or taking any other steps to derive the structure or design of the LD. Any attempt to derive the structure or design of the LD shall be deemed breach of this Agreement, and shall make the limited warranty set forth above null and void.

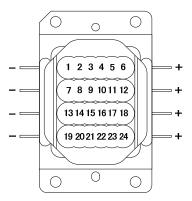
#### <u>Miscellaneous</u>

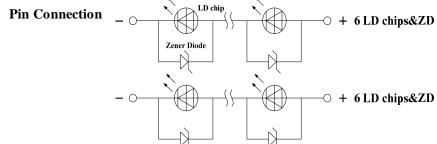
- (1) Acceptance Test: The Purchaser shall perform an acceptance test on the LD within fourteen (14) days of the date of shipment by Nichia of the LD.
- (2) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- (3) The appearance and specifications of the LD may be modified for improvement without notice
- (4) The content of this specification may be revised without notice.

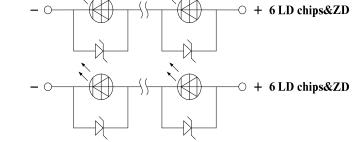


# ■ 外形寸法図 / Outline Dimension(2)

### LD chips Position No.







| 部品 Parts                                 |            | 材質 Materials   |                    |  |
|--|------------|--|--------------------|--|
| ステム                                      | Stem       | Cu+Fe+Ni めっき+Auめっき<br>Cu+Fe+Ni plating+Au plating                  |                    |  |
| リード                                      | Lead       | Ni -Fe-Co合金+Ni めっき+Au めっき<br>Ni-Fe-Co alloys+Ni plating+Au plating |                    |  |
| キャップ                                     | Cap        | Ni -Fe合金+Ni めっき<br>Ni-Fe alloys + Ni plating                       |                    |  |
| キャップガラス                                  | Cap glass  | ホウケイ酸ガラス   | Borosilicate glass |  |
| アレイレンズ                                   | Lens Array | 光学ガラス  | Optical glass      |  |
| チップ                                      | Chip       | 窒化ガリウム   | Gallium nitride    |  |
| サブマウント                                   | Sub mount  | 窒化アルミニウム   | Aluminum nitride   |  |
| Zener Diode                              |            | シリコン   | Silicon            |  |
| レンズ固定接着剤<br>Adhesive for fixing the lens |            | 樹脂   | Resin              |  |

|                    | Section     | Approve | Check        | Draw      | Unit / |
|--------------------|-------------|---------|--------------|-----------|--------|
|                    | LDT         | Ochiai  | Iwasa        | Yoshihara | mm     |
|                    | Date        | Ma      | ar. 25, 2020 |           | Scale  |
| Model              | Title 外形寸法図 |         |              | Allow     |        |
| NUxMxxE / NUxMxx   | Ol          |         |              |           |        |
| NICHIA CORPORATION | No.         | UTZ-    | ZAK06600     |           |        |

